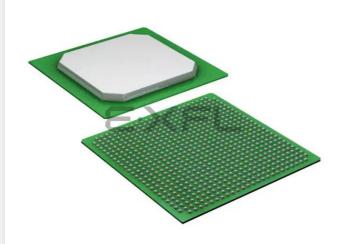
# E·XFL

# Intel - 5CGXFC9D7F27C8N Datasheet



Welcome to <u>E-XFL.COM</u>

#### Understanding <u>Embedded - FPGAs (Field</u> <u>Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

#### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

Details	
Product Status	Active
Number of LABs/CLBs	113560
Number of Logic Elements/Cells	301000
Total RAM Bits	14251008
Number of I/O	336
Number of Gates	-
Voltage - Supply	1.07V ~ 1.13V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-BGA
Supplier Device Package	672-FBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/intel/5cgxfc9d7f27c8n

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



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# **Summary of Cyclone V Features**

# Table 2. Summary of Features for Cyclone V Devices

Feature		Description				
Technology	<ul><li>TSMC's 28-nm low-p</li><li>1.1 V core voltage</li></ul>	······································				
Packaging	<ul> <li>Wirebond low-halogen packages</li> <li>Multiple device densities with compatible package footprints for seamless migration between different device densities</li> <li>RoHS-compliant and leaded<sup>(1)</sup>options</li> </ul>					
High-performance FPGA fabric	Enhanced 8-input ALM w	vith four registers				
Internal memory blocks		b) memory blocks with soft error correction code (ECC) block (MLAB)—640-bit distributed LUTRAM where you can use up to 25% memory				
Embedded Hard IP blocks	Variable-precision DSP	<ul> <li>Native support for up to three signal processing precision levels (three 9 x 9, two 18 x 18, or one 27 x 27 multiplier) in the same variable-precision DSP block</li> <li>64-bit accumulator and cascade</li> <li>Embedded internal coefficient memory</li> <li>Preadder/subtractor for improved efficiency</li> </ul>				
	Memory controller	DDR3, DDR2, and LPDDR2 with 16 and 32 bit ECC support				
	Embedded transceiver I/O	PCI Express* (PCIe*) Gen2 and Gen1 (x1, x2, or x4) hard IP with multifunction support, endpoint, and root port				
Clock networks	, , , ,	l clock network d peripheral clock networks are not used can be powered down to reduce dynamic power				
Phase-locked loops (PLLs)	<ul><li> Precision clock synth</li><li> Integer mode and fra</li></ul>	esis, clock delay compensation, and zero delay buffering (ZDB) actional mode				
FPGA General-purpose I/Os (GPIOs)	<ul><li>400 MHz/800 Mbps e</li><li>On-chip termination</li></ul>	cond (Mbps) LVDS receiver and 840 Mbps LVDS transmitter external memory interface (OCT) p to 16 mA drive strength				
Low-power high-speed serial interface	<ul> <li>614 Mbps to 6.144 Gbps integrated transceiver speed</li> <li>Transmit pre-emphasis and receiver equalization</li> <li>Dynamic partial reconfiguration of individual channels</li> </ul>					
HPS (Cyclone V SE, SX, and ST devices only)	<ul> <li>Single or dual-core Arm Cortex-A9 MPCore processor-up to 925 MHz maximum frequency with support for symmetric and asymmetric multiprocessing</li> <li>Interface peripherals—10/100/1000 Ethernet media access control (EMAC), USB 2.0 On-The-GO (OTG) controller, quad serial peripheral interface (QSPI) flash controller, NAND flash controller, Secure Digital/MultiMediaCard (SD/MMC) controller, UART, controller area network (CAN), serial peripheral interface (SPI), I<sup>2</sup>C interface, and up to 85 HPS GPIO interfaces</li> </ul>					
		-general-purpose timers, watchdog timers, direct memory access (DMA) iguration manager, and clock and reset managers				
		continued				

<sup>&</sup>lt;sup>(1)</sup> Contact Intel for availability.



Feature	Description
	<ul> <li>HPS-FPGA bridges—include the FPGA-to-HPS, HPS-to-FPGA, and lightweight HPS-to-FPGA bridges that allow the FPGA fabric to issue transactions to slaves in the HPS, and vice versa</li> <li>FPGA-to-HPS SDRAM controller subsystem—provides a configurable interface to the multiport front end (MPFE) of the HPS SDRAM controller</li> <li>Arm CoreSight<sup>™</sup> JTAG debug access port, trace port, and on-chip trace storage</li> </ul>
Configuration	<ul> <li>Tamper protection—comprehensive design protection to protect your valuable IP investments</li> <li>Enhanced advanced encryption standard (AES) design security features</li> <li>CvP</li> <li>Dynamic reconfiguration of the FPGA</li> <li>Active serial (AS) x1 and x4, passive serial (PS), JTAG, and fast passive parallel (FPP) x8 and x16 configuration options</li> <li>Internal scrubbing <sup>(2)</sup></li> <li>Partial reconfiguration <sup>(3)</sup></li> </ul>

# **Cyclone V Device Variants and Packages**

### Table 3. Device Variants for the Cyclone V Device Family

Variant	Description
Cyclone V E	Optimized for the lowest system cost and power requirement for a wide spectrum of general logic and DSP applications
Cyclone V GX	Optimized for the lowest cost and power requirement for 614 Mbps to 3.125 Gbps transceiver applications
Cyclone V GT	The FPGA industry's lowest cost and lowest power requirement for 6.144 Gbps transceiver applications
Cyclone V SE	SoC with integrated Arm-based HPS
Cyclone V SX	SoC with integrated Arm-based HPS and 3.125 Gbps transceivers
Cyclone V ST	SoC with integrated Arm-based HPS and 6.144 Gbps transceivers

# Cyclone V E

This section provides the available options, maximum resource counts, and package plan for the Cyclone V E devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Product Selector Guide.

#### **Related Information**

#### Product Selector Guide

Provides the latest information about Intel products.

<sup>(2)</sup> The SEU internal scrubbing feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.

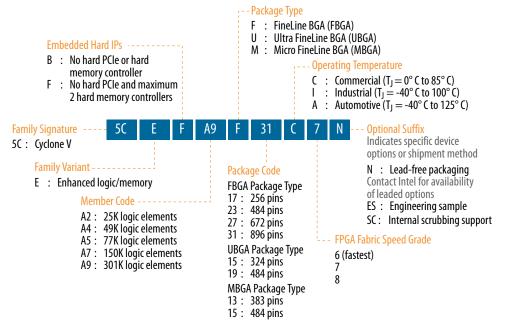
<sup>(3)</sup> The partial reconfiguration feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel<sup>®</sup> sales representatives.



# **Available Options**

### Figure 1. Sample Ordering Code and Available Options for Cyclone V E Devices

The SEU internal scrubbing feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.



### **Maximum Resources**

#### Table 4. Maximum Resource Counts for Cyclone V E Devices

Resource				Member Code		
		A2	A4	A5	A7	A9
Logic Elements	(LE) (K)	25	49	77	150	301
ALM		9,430	18,480	29,080	56,480	113,560
Register		37,736	73,920	116,320	225,920	454,240
Memory (Kb)	M10K	1,760	3,080	4,460	6,860	12,200
	MLAB	196	303	424	836	1,717
Variable-precisi	on DSP Block	25	66	150	156	342
18 x 18 Multipli	er	50	132	300	312	684
PLL		4	4	6	7	8
GPIO	GPIO		224	240	480	480
LVDS	Transmitter	56	56	60	120	120
	Receiver	56	56	60	120	120
Hard Memory C	ontroller	1	1	2	2	2



### **Related Information**

True LVDS Buffers in Devices, I/O Features in Cyclone V Devices Provides the number of LVDS channels in each device package.

### **Package Plan**

#### Table 5. Package Plan for Cyclone V E Devices

Member Code	M383 (13 mm)	M484 (15 mm)	U324 (15 mm)	F256 (17 mm)	U484 (19 mm)	F484 (23 mm)	F672 (27 mm)	F896 (31 mm)
	GPIO							
A2	223	-	176	128	224	224	-	_
A4	223	-	176	128	224	224	-	_
A5	175	-	_	_	224	240	-	_
A7	-	240	_	_	240	240	336	480
A9	-	-	-	_	240	224	336	480

# **Cyclone V GX**

This section provides the available options, maximum resource counts, and package plan for the Cyclone V GX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the *Product Selector Guide*.

### **Related Information**

Product Selector Guide

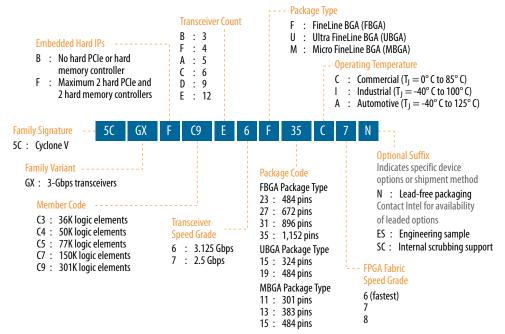
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# **Available Options**

### Figure 2. Sample Ordering Code and Available Options for Cyclone V GX Devices

The SEU internal scrubbing feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.



# **Maximum Resources**

### Table 6. Maximum Resource Counts for Cyclone V GX Devices

Resource			Member Code				
		C3	C4	C5	C7	C9	
Logic Elements	(LE) (K)	36	50	77	150	301	
ALM		13,460	18,860	29,080	56,480	113,560	
Register	Register		75,440	116,320	225,920	454,240	
Memory (Kb)	M10K	1,350	2,500	4,460	6,860	12,200	
	MLAB	182	424	424	836	1,717	
Variable-precisio	on DSP Block	57	70	150	156	342	
18 x 18 Multiplie	er	114	140	300	312	684	
PLL		4	6	6	7	8	
3 Gbps Transceiver		3	6	6	9	12	
GPIO <sup>(4)</sup>		208	336	336	480	560	
		•	1	1	1	continued	

<sup>&</sup>lt;sup>(4)</sup> The number of GPIOs does not include transceiver I/Os. In the Intel Quartus<sup>®</sup> Prime software, the number of user I/Os includes transceiver I/Os.



# **Cyclone V SE**

This section provides the available options, maximum resource counts, and package plan for the Cyclone V SE devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the *Product Selector Guide*.

#### **Related Information**

#### Product Selector Guide

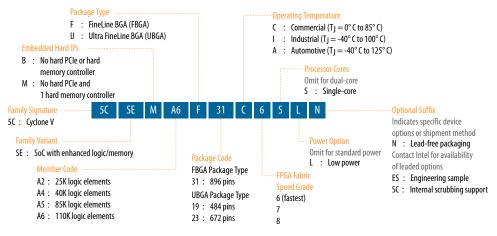
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### **Available Options**

#### Figure 4. Sample Ordering Code and Available Options for Cyclone V SE Devices

The SEU internal scrubbing feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.

Cyclone V SE and SX low-power devices (L power option) offer 30% static power reduction for devices with 25K LE and 40K LE, and 20% static power reduction for devices with 85K LE and 110K LE.





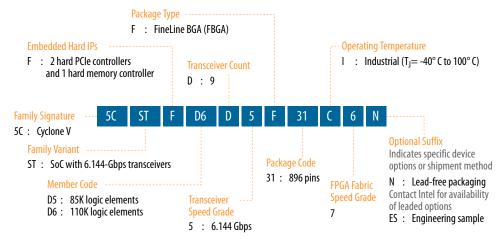
### **Related Information**

Product Selector Guide

Provides the latest information about Intel products.

# **Available Options**

### Figure 6. Sample Ordering Code and Available Options for Cyclone V ST Devices



# **Maximum Resources**

### Table 14. Maximum Resource Counts for Cyclone V ST Devices

Res	ource	Member	r Code
		D5	D6
Logic Elements (LE) (K)		85	110
ALM		32,070	41,910
Register		128,300	166,036
Memory (Kb)	M10K	3,970	5,570
	MLAB	480	621
Variable-precision DSP Block		87	112
18 x 18 Multiplier		174	224
FPGA PLL		6	6
HPS PLL		3	3
6.144 Gbps Transceiver		9	9
FPGA GPIO <sup>(10)</sup>		288	288
HPS I/O		181	181
LVDS	VDS Transmitter		72
	-		continued

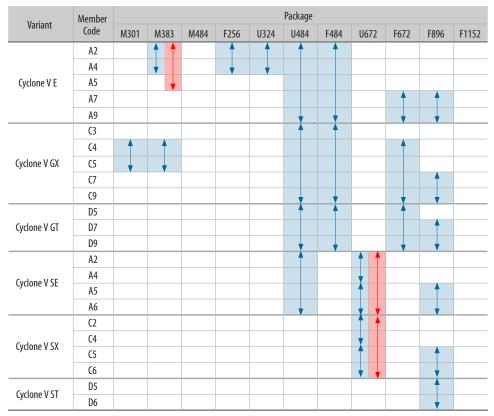
<sup>&</sup>lt;sup>(10)</sup> The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.



# **I/O Vertical Migration for Cyclone V Devices**

### Figure 7. Vertical Migration Capability Across Cyclone V Device Packages and Densities

The arrows indicate the vertical migration paths. The devices included in each vertical migration path are shaded. You can also migrate your design across device densities in the same package option if the devices have the same dedicated pins, configuration pins, and power pins.



You can achieve the vertical migration shaded in red if you use only up to 175 GPIOs for the M383 package, and 138 GPIOs for the U672 package. These migration paths are not shown in the Intel Quartus Prime software Pin Migration View.

*Note:* To verify the pin migration compatibility, use the Pin Migration View window in the Intel Quartus Prime software Pin Planner.

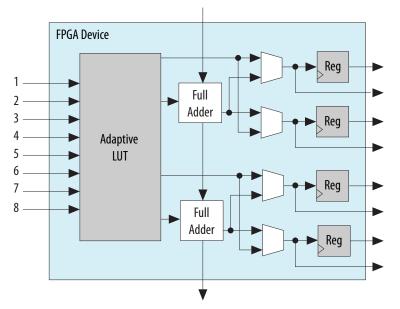
# **Adaptive Logic Module**

Cyclone V devices use a 28 nm ALM as the basic building block of the logic fabric.

The ALM, as shown in following figure, uses an 8-input fracturable look-up table (LUT) with four dedicated registers to help improve timing closure in register-rich designs and achieve an even higher design packing capability than previous generations.



#### Figure 8. ALM for Cyclone V Devices



You can configure up to 25% of the ALMs in the Cyclone V devices as distributed memory using MLABs.

#### **Related Information**

Embedded Memory Capacity in Cyclone V Devices on page 21 Lists the embedded memory capacity for each device.

# **Variable-Precision DSP Block**

Cyclone V devices feature a variable-precision DSP block that supports these features:

- Configurable to support signal processing precisions ranging from 9 x 9, 18 x 18 and 27 x 27 bits natively
- A 64-bit accumulator
- A hard preadder that is available in both 18- and 27-bit modes
- Cascaded output adders for efficient systolic finite impulse response (FIR) filters
- Internal coefficient register banks, 8 deep, for each multiplier in 18- or 27-bit mode
- Fully independent multiplier operation
- A second accumulator feedback register to accommodate complex multiplyaccumulate functions
- Fully independent Efficient support for single-precision floating point arithmetic
- The inferability of all modes by the Intel Quartus Prime design software



Variant	Member Code	Variable- precision DSP Block	-	dent Input and plications Ope	18 x 18 Multiplier Adder Mode	18 x 18 Multiplier	
		DSP BIOCK	9 x 9 Multiplier	18 x 18 Multiplier	27 x 27 Multiplier	Adder Mode	Adder Summed with 36 bit Input
	C6	112	336	224	112	112	112
Cyclone V ST	D5	87	261	174	87	87	87
	D6	112	336	224	112	112	112

# **Embedded Memory Blocks**

The embedded memory blocks in the devices are flexible and designed to provide an optimal amount of small- and large-sized memory arrays to fit your design requirements.

# **Types of Embedded Memory**

The Cyclone V devices contain two types of memory blocks:

- 10 Kb M10K blocks—blocks of dedicated memory resources. The M10K blocks are ideal for larger memory arrays while still providing a large number of independent ports.
- 640 bit memory logic array blocks (MLABs)—enhanced memory blocks that are configured from dual-purpose logic array blocks (LABs). The MLABs are ideal for wide and shallow memory arrays. The MLABs are optimized for implementation of shift registers for digital signal processing (DSP) applications, wide shallow FIFO buffers, and filter delay lines. Each MLAB is made up of ten adaptive logic modules (ALMs). In the Cyclone V devices, you can configure these ALMs as ten 32 x 2 blocks, giving you one 32 x 20 simple dual-port SRAM block per MLAB.

# **Embedded Memory Capacity in Cyclone V Devices**

# Table 18. Embedded Memory Capacity and Distribution in Cyclone V Devices

	Member	M1	.0К	ML	- Total RAM Bit	
Variant	Code	Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	(Kb)
Cyclone V E	A2	176	1,760	314	196	1,956
	A4	308	3,080	485	303	3,383
	A5	446	4,460	679	424	4,884
	A7	686	6,860	1338	836	7,696
	A9	1,220	12,200	2748	1,717	13,917
Cyclone V GX	C3	135	1,350	291	182	1,532
	C4	250	2,500	678	424	2,924
	C5	446	4,460	678	424	4,884
	C7	686	6,860	1338	836	7,696
	C9	1,220	12,200	2748	1,717	13,917
						continued



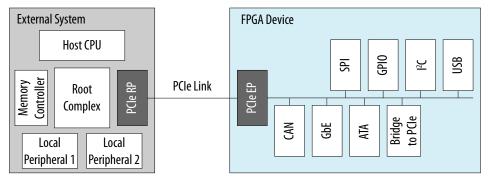
# PCIe Gen1 and Gen2 Hard IP

Cyclone V GX, GT, SX, and ST devices contain PCIe hard IP that is designed for performance and ease-of-use. The PCIe hard IP consists of the MAC, data link, and transaction layers.

The PCIe hard IP supports PCIe Gen2 and Gen1 end point and root port for up to x4 lane configuration. The PCIe Gen2 x4 support is PCIe-compatible.

The PCIe endpoint support includes multifunction support for up to eight functions, as shown in the following figure. The integrated multifunction support reduces the FPGA logic requirements by up to 20,000 LEs for PCIe designs that require multiple peripherals.

### Figure 9. PCIe Multifunction for Cyclone V Devices



The Cyclone V PCIe hard IP operates independently from the core logic. This independent operation allows the PCIe link to wake up and complete link training in less than 100 ms while the Cyclone V device completes loading the programming file for the rest of the device.

In addition, the PCIe hard IP in the Cyclone V device provides improved end-to-end datapath protection using ECC.

# **External Memory Interface**

This section provides an overview of the external memory interface in Cyclone V devices.

# Hard and Soft Memory Controllers

Cyclone V devices support up to two hard memory controllers for DDR3, DDR2, and LPDDR2 SDRAM devices. Each controller supports 8 to 32 bit components of up to 4 gigabits (Gb) in density with two chip selects and optional ECC. For the Cyclone V SoC devices, an additional hard memory controller in the HPS supports DDR3, DDR2, and LPDDR2 SDRAM devices.

All Cyclone V devices support soft memory controllers for DDR3, DDR2, and LPDDR2 SDRAM devices for maximum flexibility.



# **External Memory Performance**

### Table 20. External Memory Interface Performance in Cyclone V Devices

The maximum and minimum operating frequencies depend on the memory interface standards and the supported delay-locked loop (DLL) frequency listed in the device datasheet.

Interface	Voltage	Maximum Free	quency (MHz)	Minimum Frequency
	(V)	Hard Controller	Soft Controller	(MHz)
DDR3 SDRAM	1.5	400	303	303
	1.35	400	303	303
DDR2 SDRAM	1.8	400	300	167
LPDDR2 SDRAM	1.2	333	300	167

#### **Related Information**

External Memory Interface Spec Estimator

For the latest information and to estimate the external memory system performance specification, use Intel's External Memory Interface Spec Estimator tool.

# **HPS External Memory Performance**

### Table 21. HPS External Memory Interface Performance

The hard processor system (HPS) is available in Cyclone V SoC devices only.

Interface	Voltage (V)	HPS Hard Controller (MHz)
DDR3 SDRAM	1.5	400
	1.35	400
DDR2 SDRAM	1.8	400
LPDDR2 SDRAM	1.2	333

### **Related Information**

#### External Memory Interface Spec Estimator

For the latest information and to estimate the external memory system performance specification, use Intel's External Memory Interface Spec Estimator tool.

# **Low-Power Serial Transceivers**

Cyclone V devices deliver the industry's lowest power 6.144 Gbps transceivers at an estimated 88 mW maximum power consumption per channel. Cyclone V transceivers are designed to be compliant with a wide range of protocols and data rates.

# **Transceiver Channels**

The transceivers are positioned on the left outer edge of the device. The transceiver channels consist of the physical medium attachment (PMA), physical coding sublayer (PCS), and clock networks.





PCS Support	Data Rates (Gbps)	Transmitter Data Path Feature	Receiver Data Path Feature
Serial ATA Gen1 and Gen2	1.5 and 3.0	<ul> <li>Custom PHY IP core with preset feature</li> <li>Electrical idle</li> </ul>	<ul> <li>Custom PHY IP core with preset feature</li> <li>Signal detect</li> <li>Wider spread of asynchronous SSC</li> </ul>
CPRI 4.1 <sup>(16)</sup>	0.6144 to 6.144	Dedicated deterministic latency PHY IP core	Dedicated deterministic latency PHY IP core
OBSAI RP3	0.768 to 3.072	Transmitter (TX) manual bit-slip mode	Receiver (RX) deterministic     latency state machine
V-by-One HS	Up to 3.75	Custom PHY IP core	Custom PHY IP core
DisplayPort 1.2 <sup>(17)</sup>	1.62 and 2.7		Wider spread of asynchronous     SSC

# **SoC with HPS**

Each SoC combines an FPGA fabric and an HPS in a single device. This combination delivers the flexibility of programmable logic with the power and cost savings of hard IP in these ways:

- Reduces board space, system power, and bill of materials cost by eliminating a discrete embedded processor
- Allows you to differentiate the end product in both hardware and software, and to support virtually any interface standard
- Extends the product life and revenue through in-field hardware and software updates

# **HPS Features**

The HPS consists of a dual-core Arm Cortex-A9 MPCore processor, a rich set of peripherals, and a shared multiport SDRAM memory controller, as shown in the following figure.

<sup>&</sup>lt;sup>(16)</sup> High-voltage output mode (1000-BASE-CX) is not supported.

<sup>&</sup>lt;sup>(17)</sup> Pending characterization.



*Note:* Although the FPGA fabric and HPS are on separate power domains, the HPS must remain powered up during operation while the FPGA fabric can be powered up or down as required.

#### **Related Information**

Cyclone V Device Family Pin Connection Guidelines

Provides detailed information about power supply pin connection guidelines and power regulator sharing.

### **Hardware and Software Development**

For hardware development, you can configure the HPS and connect your soft logic in the FPGA fabric to the HPS interfaces using the Platform Designer (Standard) system integration tool in the Intel Quartus Prime software.

For software development, the Arm-based SoC devices inherit the rich software development ecosystem available for the Arm Cortex-A9 MPCore processor. The software development process for Intel SoCs follows the same steps as those for other SoC devices from other manufacturers. Support for Linux, VxWorks<sup>®</sup>, and other operating systems is available for the SoCs. For more information on the operating systems support availability, contact the Intel sales team.

You can begin device-specific firmware and software development on the Intel SoC Virtual Target. The Virtual Target is a fast PC-based functional simulation of a target development system—a model of a complete development board that runs on a PC. The Virtual Target enables the development of device-specific production software that can run unmodified on actual hardware.

#### **Related Information**

International Altera Sales Support Offices

# **Dynamic and Partial Reconfiguration**

The Cyclone V devices support dynamic reconfiguration and partial reconfiguration.

# **Dynamic Reconfiguration**

The dynamic reconfiguration feature allows you to dynamically change the transceiver data rates, PMA settings, or protocols of a channel, without affecting data transfer on adjacent channels. This feature is ideal for applications that require on-the-fly multiprotocol or multirate support. You can reconfigure the PMA and PCS blocks with dynamic reconfiguration.

# **Partial Reconfiguration**

*Note:* The partial reconfiguration feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.

Partial reconfiguration allows you to reconfigure part of the device while other sections of the device remain operational. This capability is important in systems with critical uptime requirements because it allows you to make updates or adjust functionality without disrupting services.



Apart from lowering cost and power consumption, partial reconfiguration increases the effective logic density of the device because placing device functions that do not operate simultaneously is not necessary. Instead, you can store these functions in external memory and load them whenever the functions are required. This capability reduces the size of the device because it allows multiple applications on a single device—saving the board space and reducing the power consumption.

Intel simplifies the time-intensive task of partial reconfiguration by building this capability on top of the proven incremental compile and design flow in the Intel Quartus Prime design software. With the Intel solution, you do not need to know all the intricate device architecture details to perform a partial reconfiguration.

Partial reconfiguration is supported through the FPP x16 configuration interface. You can seamlessly use partial reconfiguration in tandem with dynamic reconfiguration to enable simultaneous partial reconfiguration of both the device core and transceivers.

# **Enhanced Configuration and Configuration via Protocol**

Cyclone V devices support 1.8 V, 2.5 V, 3.0 V, and 3.3 V programming voltages and several configuration schemes.

Mode	Data Width	Max Clock Rate (MHz)	Max Data Rate (Mbps)	Decompressi on	Design Security	Partial Reconfigurat ion <sup>(18)</sup>	Remote System Update
AS through the EPCS and EPCQ serial configuration device	1 bit, 4 bits	100	_	Yes	Yes	_	Yes
PS through CPLD or external microcontroller	1 bit	125	125	Yes	Yes	_	_
FPP	8 bits	125	_	Yes	Yes	_	Parallel flash
	16 bits	125	_	Yes	Yes	Yes	loader
CvP (PCIe)	x1, x2, and x4 lanes	-	_	Yes	Yes	Yes	_
JTAG	1 bit	33	33	-	_	_	_

 Table 24.
 Configuration Schemes and Features Supported by Cyclone V Devices

Instead of using an external flash or ROM, you can configure the Cyclone V devices through PCIe using CvP. The CvP mode offers the fastest configuration rate and flexibility with the easy-to-use PCIe hard IP block interface. The Cyclone V CvP implementation conforms to the PCIe 100 ms power-up-to-active time requirement.

# **Related Information**

Configuration via Protocol (CvP) Implementation in Intel FPGAs User Guide Provides more information about CvP.

<sup>&</sup>lt;sup>(18)</sup> The partial reconfiguration feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.



# **Power Management**

Leveraging the FPGA architectural features, process technology advancements, and transceivers that are designed for power efficiency, the Cyclone V devices consume less power than previous generation Cyclone FPGAs:

- Total device core power consumption—less by up to 40%.
- Transceiver channel power consumption—less by up to 50%.

Additionally, Cyclone V devices contain several hard IP blocks that reduce logic resources and deliver substantial power savings of up to 25% less power than equivalent soft implementations.

# **Document Revision History for Cyclone V Device Overview**

Document Version	Changes
2018.05.07	<ul> <li>Added the low power option ("L" suffix) for Cyclone V SE and Cyclone V SX devices in the Sample Ordering Code and Available Options diagrams.</li> <li>Rebranded as Intel.</li> </ul>

Date	Version	Changes
December 2017	2017.12.18	Updated ALM resources for Cyclone V E, Cyclone V SE, Cyclone V SX, and Cyclone V ST devices.
June 2016	2016.06.10	Updated Cyclone V GT speed grade to $-7$ in Sample Ordering Code and Available Options for Cyclone V GT Devices diagram.
December 2015	2015.12.21	<ul> <li>Added descriptions to package plan tables for Cyclone V GT and ST devices.</li> <li>Changed instances of <i>Quartus II</i> to <i>Quartus Prime</i>.</li> </ul>
June 2015	2015.06.12	<ul> <li>Replaced a note to partial reconfiguration feature. Note: The partial reconfiguration feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Altera sales representatives.</li> <li>Updated logic elements (LE) (K) for the following devices: <ul> <li>Cyclone V E A7: Updated from 149.5 to 150</li> <li>Cyclone V GX C3: Updated from 149.7 to 150</li> <li>Cyclone V GT D7: Updated from 149.5 to 150</li> <li>Cyclone V GT D7: Updated from 149.5 to 150</li> </ul> </li> <li>Updated MLAB (Kb) in Maximum Resource Counts for Cyclone V GX Devices table as follows: <ul> <li>Cyclone V GX C3: Updated from 291 to 182</li> <li>Cyclone V GX C4: Updated from 678 to 424</li> <li>Cyclone V GX C7: Updated from 1,338 to 836</li> <li>Cyclone V GX C9: Updated from 1,717</li> </ul> </li> </ul>
	1	continued

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Date	Version	Changes
		<ul> <li>Updated MLAB RAM Bit (Kb) in Embedded Memory Capacity and Distribution in Cyclone V Devices table as follows:</li> <li>Cyclone V GX C3: Updated from 181 to 182</li> <li>Cyclone V GX C4: Updated from 295 to 424</li> <li>Updated Total RAM Bit (Kb) in Embedded Memory Capacity and Distribution in Cyclone V Devices table as follows:</li> <li>Cyclone V GX C3: Updated from 1,531 to 1,532</li> <li>Cyclone V GX C4: Updated from 2,795 to 2,924</li> <li>Updated MLAB Block count in Embedded Memory Capacity and Distribution in Cyclone V Devices table as follows:</li> <li>Cyclone V GX C4: Updated from 2,795 to 2,924</li> <li>Updated MLAB Block count in Embedded Memory Capacity and Distribution in Cyclone V Devices table as follows:</li> <li>Cyclone V GX C4: Updated from 472 to 678</li> <li>Cyclone V GX C5: Updated from 679 to 678</li> </ul>
March 2015	2015.03.31	<ul> <li>Added internal scrubbing feature under configuration in Summary of Features for Cyclone V Devices table.</li> <li>Added optional suffix "SC: Internal scrubbing support" to the following diagrams: <ul> <li>Sample Ordering Code and Available Options for Cyclone V E Devices</li> <li>Sample Ordering Code and Available Options for Cyclone V GX Devices</li> <li>Sample Ordering Code and Available Options for Cyclone V SE Devices</li> <li>Sample Ordering Code and Available Options for Cyclone V SE Devices</li> </ul> </li> </ul>
January 2015	2015.01.23	<ul> <li>Updated Sample Ordering Code and Available Options for Cyclone V ST Devices figure because Cyclone V ST devices are only available in I temperature grade and -7 speed grade.</li> <li>Operating Temperature: Removed C and A temperature grades</li> <li>FPGA Fabric Speed Grade: Removed -6 and -8 speed grades</li> <li>Updated the transceiver specification for Cyclone V ST from 5 Gbps to 6.144 Gbps:         <ul> <li>Device Variants for the Cyclone V Device Family table</li> <li>Sample Ordering Code and Available Options for Cyclone V ST Devices figure</li> <li>Maximum Resource Counts for Cyclone V ST Devices</li> <li>Updated Maximum Resource Counts for Cyclone V GX Devices table for Cyclone V GX G3 devices.</li> <li>Logic elements (LE) (K): Updated from 35.7 to 35.5</li> <li>Variable-precision DSP block: Updated from 51 to 57</li> <li>18 x 18 multiplier: Updated from 102 to 114</li> </ul> </li> <li>Updated Number of Multipliers in Cyclone V Devices table for Cyclone V GX G3 devices.</li> <ul> <li>Variableprecision DSP Block: Updated from 51 to 57</li> <li>9 x 9 Multiplier: Updated from 102 to 114</li> </ul> <li>Updated Number of Multipliers in Cyclone V Devices table for Cyclone V GX G3 devices.</li> <ul> <li>Variableprecision DSP Block: Updated from 51 to 57</li> <li>9 x 9 Multiplier: Updated from 102 to 114</li> </ul> <li>Updated Rumory Capacity and Distribution in Cyclone V Devices table for Cyclone V GX G3 devices.</li> <ul> <li>Multiplier Adder Mode: Updated from 51 to 57</li> <li>18 x 18 Multiplier Adder Summed with 36 bit Input: Updated from 51 to 57</li> <li>18 x 18 Multiplier Adder Summed with 36 bit Input: Updated from 51 to 57</li> <li>M10K RAM bit (Kb): Updated from 1,190 to 1,350</li> <li>M10K RAM bit (Kb): Updated from 1,190 to 1,350</li> <li>MLAB Block: Upda</li></ul></ul>
October 2014	2014.10.06	Added a footnote to the "Transceiver PCS Features for Cyclone V Devices"
		table to show that PCIe Gen2 is supported for Cyclone V GT and ST devices. continued

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Cyclone V SE and SX devices.           December 2013         2013.12.26         Corrected single or dual-core ARM Cortex-A9 MPCore processor-up to 925 Mitz from 800 Mitz.           Removed "Preliminary" texts from Ordering Code figures, Maximum Resources, Package Plan and I/O Vertical Migration tables.         Removed the note "The number of GPIOs does not include transceiver I/Os. In the Quartus II software, the number of user I/Os includes transceiver I/Os. In the Maximum Resources Counts table for Cyclone V E and SE.           Added leaded package options.         Removed the note "The number of PLLs includes guerant.           Updated Timbedded Hard IPs for Cyclone V GT devices to indicate Maximum 2 hard PCIe and 2 hard memory controllers.         Addeel deaded package options.           Removed the note "The number of PLLs includes gueran-purpose fractional PLLs and transceiver fractional PLLs." for all PLLs in the Maximum Resource Counts table.         Corrected max LVDS counts for transmitter and receiver for Cyclone V E A5 device from 34 to 50.           Corrected variable-precision DSP block, 27 x 27 multiplier, 18 x 18 multiplier adder summed with 36 bit input for Cyclone V SE devices from 116 to 150.         Corrected VAS and VAS are validated and VA as well as SX C2 and C4 devices from 35 to 32.           Corrected VDS transmitter for Cyclone V SE A2 and A4 as well as SX C2 and C4 devices from 35 to 32.         Corrected VAS from 35 to 32.           Corrected VADI is supported through the soft PCS in the PCS features for Cyclone V SE A2 and A4 as well as SX C2 and C4 devices from 35 to 32.         Corrected VADI is supported through the soft PCS in the PCS features for Cyclone V SE A2 and A4 a	Date	Version	Changes
MHz from 800 MHz.         Removed "Preliminary" texts from Ordering Code figures, Maximum Resources, Package Plan and I/O Vertical Migration tables.         Removed the note "The number of GPI05 does not include transceiver I/Os. In the Quartus II software, the number of user /Os includes transceiver I/Os. The GPI05 in the Maximum Resource Counts table for Cyclone V E and SE.         • Added limk to Altera Product Selector for each device variant.         • Updated Embedded Hard IPs for Cyclone V GT devices to indicate Maximum 2 hard PCI2 and 2 hard memory controllers.         • Added leaded package options.         • Removed the note. "The number of PLLs includes general-purpose fractional PLLs and transceiver fractional PLLs." for all PLLs in the Maximum Resource Counts table.         • Corrected max LVDS counts for transmitter and receiver for Cyclone V E AS device from 14 to 120.         • Corrected max LVDS counts for transmitter and receiver for Cyclone V E AS devices from 31 to 120.         • Corrected 18 x 18 multiplier of Cyclone V SE devices from 116 to 168.         • Corrected 1VDS transmitter for Cyclone V SE A2 and A4 as well as SX C2 and C4 devices from 31 to 32.         • Corrected 1VDS reavers for Cyclone V SE A2 and A4 as well as SX C2 and C4 devices from 31 to 32.         • Corrected 1VDS reavers from May Cycle SE A3 and A4 as well as SX C2 and C4 devices from 31 to 32.         • Corrected AVLDI is supported through the soft PCS in the PCS features for Cyclone V.         • Added the DDR3 SDRAM for the maximum frequency's soft controller and the minimum frequency from 300 to 303 for vollege 1.35V.	July 2014	2014.07.07	Updated the I/O vertical migration figure to clarify the migration capability of Cyclone V SE and SX devices.
<ul> <li>Corrected 18 x 18 multiplier for Cyclone V SE devices from 116 to 168.</li> <li>Corrected 9 x 9 multiplier for Cyclone V SE devices from 174 to 252.</li> <li>Corrected LVDS transmitter for Cyclone V SE A2 and A4 as well as SX C2 and C4 devices from 31 to 32.</li> <li>Corrected LVDS receiver for Cyclone V SE A2 and A4 as well as SX C2 and C4 devices from 35 to 37.</li> <li>Corrected transceiver speed grade for Cyclone V ST devices ordering code from 4 to 5.</li> <li>Updated the DDR3 SDRAM for the maximum frequency's soft controller and the minimum frequency from 300 to 303 for voltage 1.35V.</li> <li>Added links to Altera's External Memory Spec Estimator tool to the topics listing the external memory interface performance.</li> <li>Corrected XAUI is supported through the soft PCS in the PCS features for Cyclone V.</li> <li>Added links to the known document issues in the Knowledge Base.</li> <li>Moved all links to the Related Information section of respective topics for easy reference.</li> <li>Corrected the Supporting Feature in Table 1 of Increased bandwidth capacity to '6.144 Gbps'.</li> <li>Updated Description in Table 2 of Low-power high-speed serial interface to '6.144 Gbps'.</li> <li>Updated Description in Table 3 of Cyclone V GT to '6.144 Gbps'.</li> <li>Updated LVDS in the Maximum Resource Counts tables to include Transmitter and Receiver values.</li> <li>Updated LVDS in the Maximum Resource Counts tables to include Transmitter and Receiver values.</li> <li>Updated He package plan with M383 for the Cyclone V E device.</li> <li>Removed the M301 and M383 packages from the Cyclone V GX C4 device</li> <li>Updated the GPI0 count to '129' for the M301 package of the Cyclone V</li> </ul>	December 2013	2013.12.26	<ul> <li>Corrected single or dual-core ARM Cortex-A9 MPCore processor-up to 925 MHz from 800 MHz.</li> <li>Removed "Preliminary" texts from Ordering Code figures, Maximum Resources, Package Plan and I/O Vertical Migration tables.</li> <li>Removed the note "The number of GPIOs does not include transceiver I/Os. In the Quartus II software, the number of user I/Os includes transceiver I/Os." for GPIOs in the Maximum Resource Counts table for Cyclone V E and SE.</li> <li>Added link to Altera Product Selector for each device variant.</li> <li>Updated Embedded Hard IPs for Cyclone V GT devices to indicate Maximum 2 hard PCIe and 2 hard memory controllers.</li> <li>Added leaded package options.</li> <li>Removed the note "The number of PLLs includes general-purpose fractional PLLs and transceiver fractional PLLs." for all PLLs in the Maximum Resource Counts table.</li> <li>Corrected max LVDS counts for transmitter and receiver for Cyclone V E A9 device from 140 to 120.</li> <li>Corrected variable-precision DSP block, 27 x 27 multiplier, 18 x 18 multiplier adder mode and 18 x 18 multiplier adder summed with 36 bit</li> </ul>
<ul> <li>May 2013</li> <li>2013.05.06</li> <li>Added link to the known document issues in the Knowledge Base.</li> <li>Moved all links to the Related Information section of respective topics for easy reference.</li> <li>Corrected the title to the PCIe hard IP topic. Cyclone V devices support only PCIe Gen1 and Gen2.</li> <li>Updated Supporting Feature in Table 1 of Increased bandwidth capacity to '6.144 Gbps'.</li> <li>Updated Description in Table 2 of Low-power high-speed serial interface to '6.144 Gbps'.</li> <li>Updated Description in Table 3 of Cyclone V GT to '6.144 Gbps'.</li> <li>Updated the M386 package to M383 for Figure 1, Figure 2 and Figure 3.</li> <li>Updated LVDS in the Maximum Resource Counts tables to include Transmitter and Receiver values.</li> <li>Updated the m301 and M383 packages from the Cyclone V GX C4 device</li> <li>Updated the GPIO count to '129' for the M301 package of the Cyclone V</li> </ul>			<ul> <li>Corrected 18 x 18 multiplier for Cyclone V SE devices from 116 to 168.</li> <li>Corrected 9 x 9 multiplier for Cyclone V SE devices from 174 to 252.</li> <li>Corrected LVDS transmitter for Cyclone V SE A2 and A4 as well as SX C2 and C4 devices from 31 to 32.</li> <li>Corrected LVDS receiver for Cyclone V SE A2 and A4 as well as SX C2 and C4 devices from 35 to 37.</li> <li>Corrected transceiver speed grade for Cyclone V ST devices ordering code from 4 to 5.</li> <li>Updated the DDR3 SDRAM for the maximum frequency's soft controller and the minimum frequency from 300 to 303 for voltage 1.35V.</li> <li>Added links to Altera's External Memory Spec Estimator tool to the topics listing the external memory interface performance.</li> <li>Corrected XAUI is supported through the soft PCS in the PCS features for Cyclone V.</li> </ul>
Updated 5 Gbps to '6.144 Gbps' forCyclone V GT device.	May 2013	2013.05.06	<ul> <li>Added link to the known document issues in the Knowledge Base.</li> <li>Moved all links to the Related Information section of respective topics for easy reference.</li> <li>Corrected the title to the PCIe hard IP topic. Cyclone V devices support only PCIe Gen1 and Gen2.</li> <li>Updated Supporting Feature in Table 1 of Increased bandwidth capacity to '6.144 Gbps'.</li> <li>Updated Description in Table 2 of Low-power high-speed serial interface to '6.144 Gbps'.</li> <li>Updated Description in Table 3 of Cyclone V GT to '6.144 Gbps'.</li> <li>Updated the M386 package to M383 for Figure 1, Figure 2 and Figure 3.</li> <li>Updated Figure 2 and Figure 3 for Transceiver Count by adding 'F : 4'.</li> <li>Updated the package plan with M383 for the Cyclone V E device.</li> <li>Removed the M301 and M383 packages from the Cyclone V GX C4 device.</li> <li>Updated the GPIO count to '129' for the M301 package of the Cyclone V GX C5 device.</li> </ul>

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Date	Version	Changes
		<ul> <li>Updated Figure 1, Figure 2, Figure 3, Figure 4, Figure 5, Figure 6, and Figure 10.</li> <li>Updated the "FPGA Configuration and Processor Booting" and "Hardware and Software Development" sections.</li> <li>Text edits throughout the document.</li> </ul>
February 2012	1.2	<ul> <li>Updated Table 1–2, Table 1–3, and Table 1–6.</li> <li>Updated "Cyclone V Family Plan" on page 1–4 and "Clock Networks and PLL Clock Sources" on page 1–15.</li> <li>Updated Figure 1–1 and Figure 1–6.</li> </ul>
November 2011	1.1	<ul> <li>Updated Table 1–1, Table 1–2, Table 1–3, Table 1–4, Table 1–5, and Table 1–6.</li> <li>Updated Figure 1–4, Figure 1–5, Figure 1–6, Figure 1–7, and Figure 1–8.</li> <li>Updated "System Peripherals" on page 1–18, "HPS-FPGA AXI Bridges" on page 1–19, "HPS SDRAM Controller Subsystem" on page 1–19, "FPGA Configuration and Processor Booting" on page 1–19, and "Hardware and Software Development" on page 1–20.</li> <li>Minor text edits.</li> </ul>
October 2011	1.0	Initial release.